



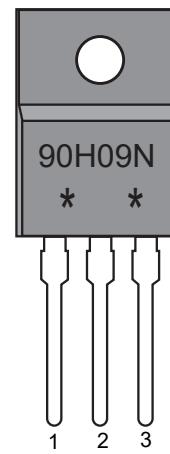
PJM90H09NTF

N-Channel MOSFET

Feature

- Fast switching capability
- $R_{DS(on)}=1.4\Omega$ @ $V_{GS}=10V$
- Ultra low gate charge
- Low reverse transfer capacitance
- Avalanche energy specified

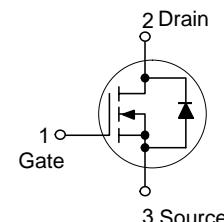
TO-220F



Marking

90H09N: Product Type

* * : Date of Manufacture



PJM90H09NTF Explanation

PJ: Brand of abbreviation

M: MOSFET

90H09: Product type

N: Channel type

TF: Package type

Absolute Maximum Ratings

($T_c=25^\circ C$ unless otherwise stated)

| Parameter | Symbol | Value | Units |
|--|----------------|-----------------|------------|
| Drain-Source Voltage | V_{DSS} | 900 | V |
| Gate-Source Voltage | V_{GSS} | ± 30 | V |
| Continuous Drain Current | I_D | 9 | A |
| Pulsed Drain Current | I_{DM} | 36 | A |
| Avalanche Energy (Single Pulsed) ^(Note 1) | E_{AS} | 823 | mJ |
| Power Dissipation | P_D | 68 | W |
| Junction and Storage Temperature Range | T_J, T_{STG} | 150, -55 to 150 | $^\circ C$ |

Thermal Characteristics

| Parameter | Symbol | Typ. | Units |
|-----------------------------|-----------------|------|--------------|
| Maximum Junction-to-Ambient | $R_{\theta JA}$ | 120 | $^\circ C/W$ |
| Maximum Junction-to-Case | $R_{\theta JC}$ | 1.84 | $^\circ C/W$ |



Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

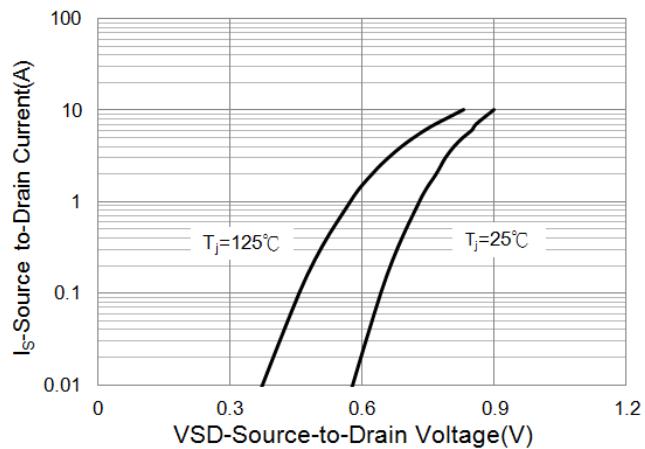
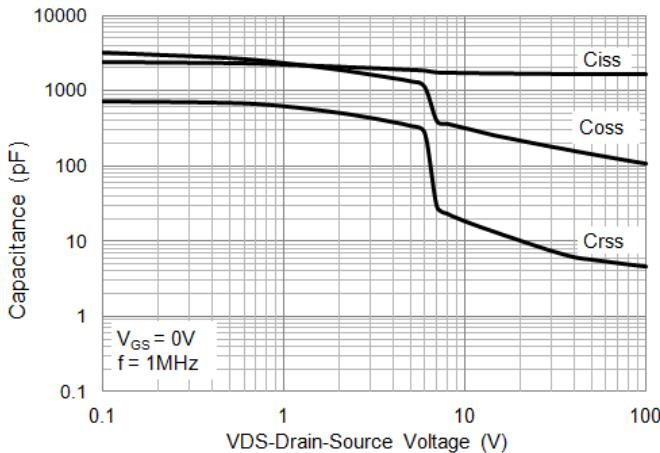
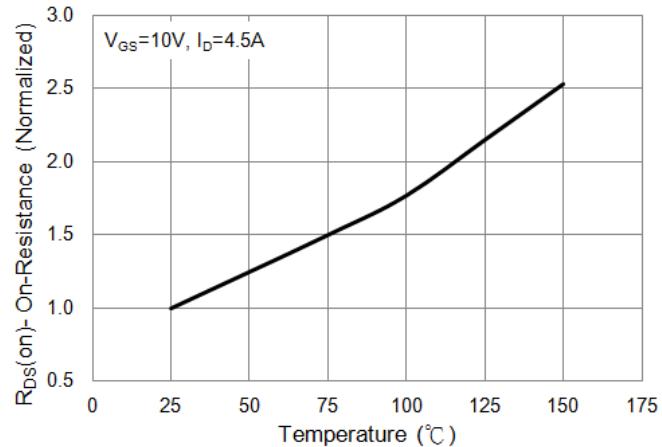
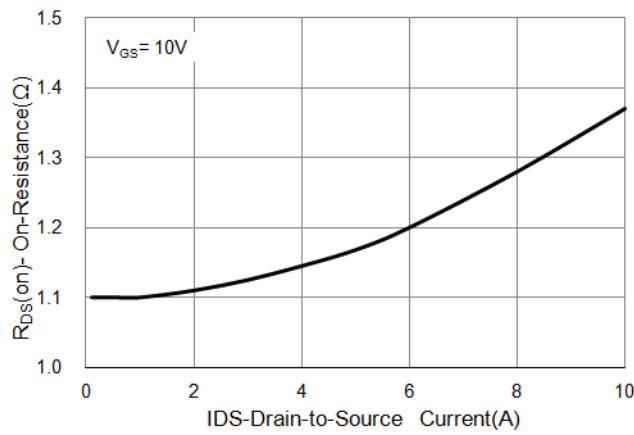
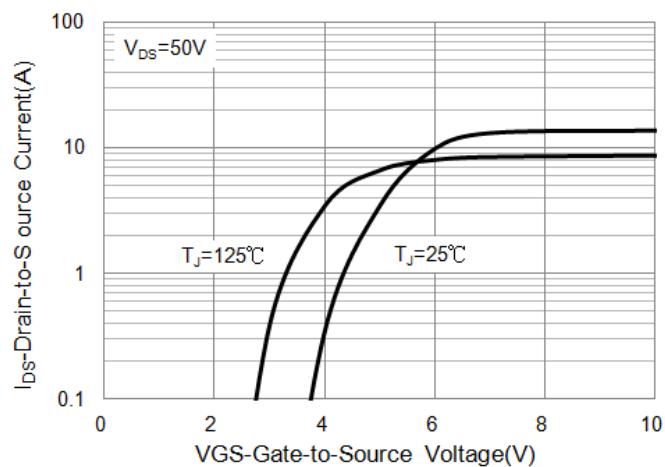
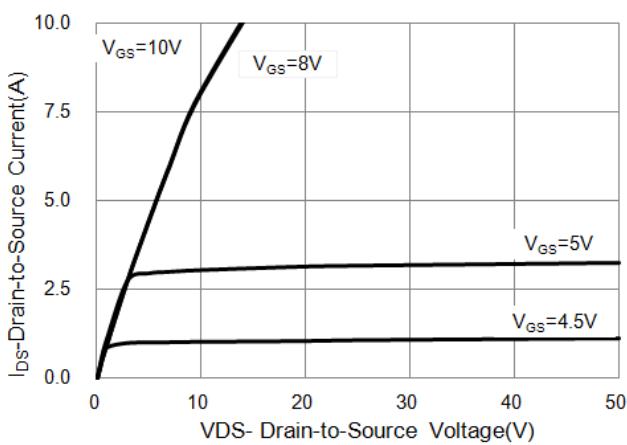
| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|---|--------------------------|--|------|------|-----------|---------------|
| Static Parameters | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$ | 900 | -- | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=900\text{V}, V_{GS}=0\text{V}$ | -- | -- | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$ | -- | -- | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(\text{th})}$ | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | 2 | -- | 4 | V |
| Static Drain-Source On-Resistance | $R_{DS(\text{ON})}$ | $V_{GS}=10\text{V}, I_D=4.5\text{A}$ | -- | -- | 1.4 | Ω |
| Body Diode Forward Voltage | V_{SD} | $I_S=9\text{A}, V_{GS}=0\text{V}$ | -- | -- | 1.4 | V |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$ | -- | 1634 | -- | pF |
| Output Capacitance | C_{oss} | | -- | 143 | -- | pF |
| Reverse Transfer Capacitance | C_{rss} | | -- | 7.1 | -- | pF |
| Switching Parameters (Note 2,3) | | | | | | |
| Total Gate Charge | Q_g | $V_{GS}=10\text{V}, V_{DS}=720\text{V}, I_D=9\text{A}$ | -- | 31 | -- | nC |
| Gate Source Charge | Q_{gs} | | -- | 8 | -- | nC |
| Gate Drain Charge | Q_{gd} | | -- | 12 | -- | nC |
| Turn-On Delay Time | $t_{D(on)}$ | $V_{DD}=450\text{V}, I_D=9\text{A}, R_G=25\Omega$ | -- | 22 | -- | ns |
| Turn-On Rise Time | t_r | | -- | 31 | -- | ns |
| Turn-Off Delay Time | $t_{D(off)}$ | | -- | 56 | -- | ns |
| Turn-Off Fall Time | t_f | | -- | 31 | -- | ns |
| Drain-Source Diode | | | | | | |
| Maximum Continuous Drain-Source Diode Forward Current | I_S | | -- | -- | 9 | A |
| Maximum Pulsed Drain-Source Diode Forward Current | I_{SM} | | -- | -- | 36 | A |

Note:

1. $L = 30\text{mH}, I_{AS} = 7.1\text{A}, V_{DD} = 50\text{V}, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.
2. Pulse Test: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.



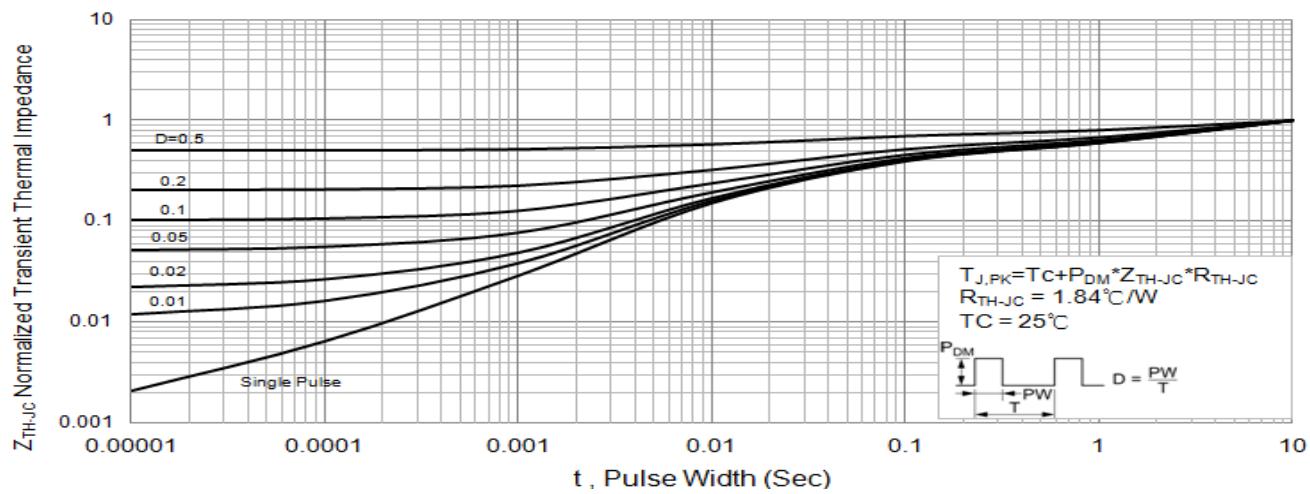
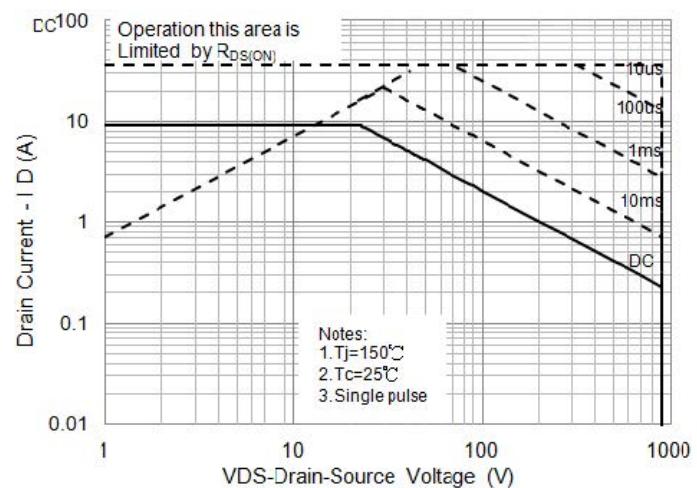
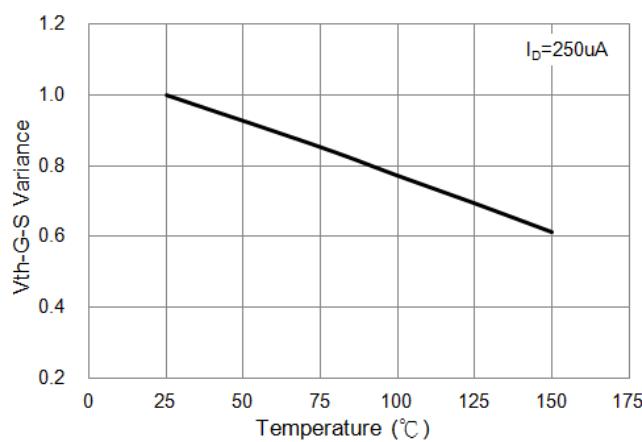
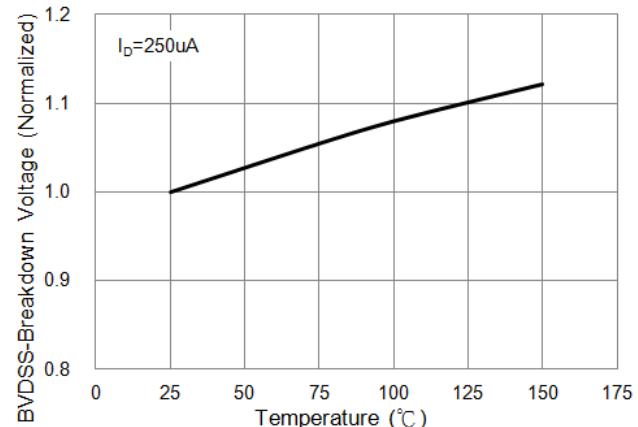
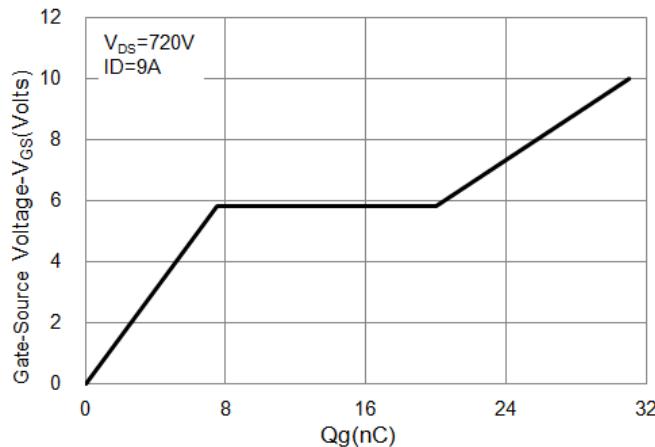
Electrical Characteristics Curves





PJM90H09NTF

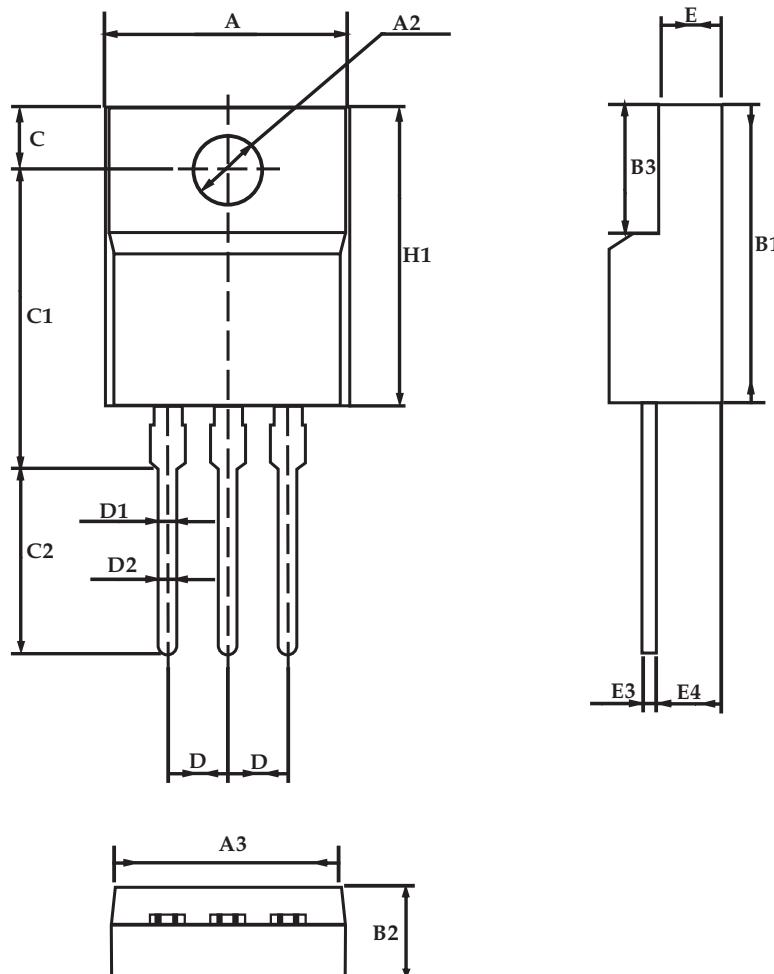
N-Channel MOSFET





Package Outline

TO-220F



UNIT : mm

| SYMBOL | min | nom | max | SYMBOL | min | nom | max |
|--------|-------|------|-------|--------|------|---------|------|
| A | 9.80 | | 10.60 | D | | 2.54 | |
| A1 | | 7.00 | | D1 | 1.15 | | 1.55 |
| A2 | 2.90 | | 3.40 | D2 | 0.60 | | 1.00 |
| A3 | 9.10 | | 9.90 | D3 | 0.20 | | 0.50 |
| B1 | 15.40 | | 16.40 | E | 2.24 | | 2.84 |
| B2 | 4.35 | | 4.95 | E1 | | 0.70 | |
| B3 | 6.00 | | 7.40 | E2 | | 1.0×45° | |
| C | 3.00 | | 3.70 | E3 | 0.35 | | 0.65 |
| C1 | 15.00 | | 17.00 | E4 | 2.30 | | 3.30 |
| C2 | 8.80 | | 10.80 | α (度) | | 30° | |

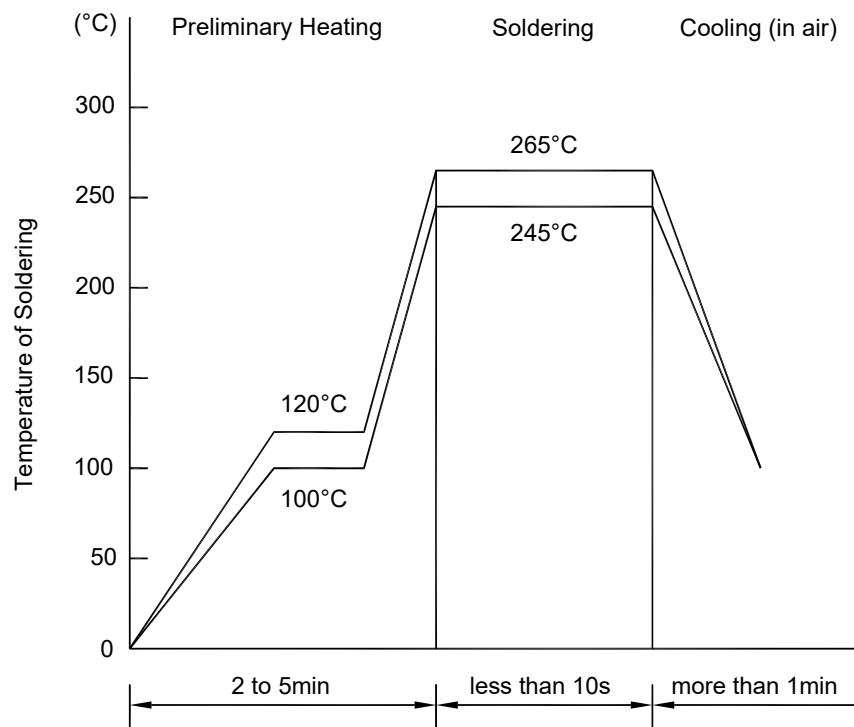
Ordering Information

| Device | Package | Shipping |
|-------------|---------|-------------|
| PJM90H09NTF | TO-220F | 50 PCS/TUBE |



Conditions of Soldering and Storage

- Recommended condition of flow soldering



Condition of hand soldering

Temperature: 370 °C

Time: 3s max.

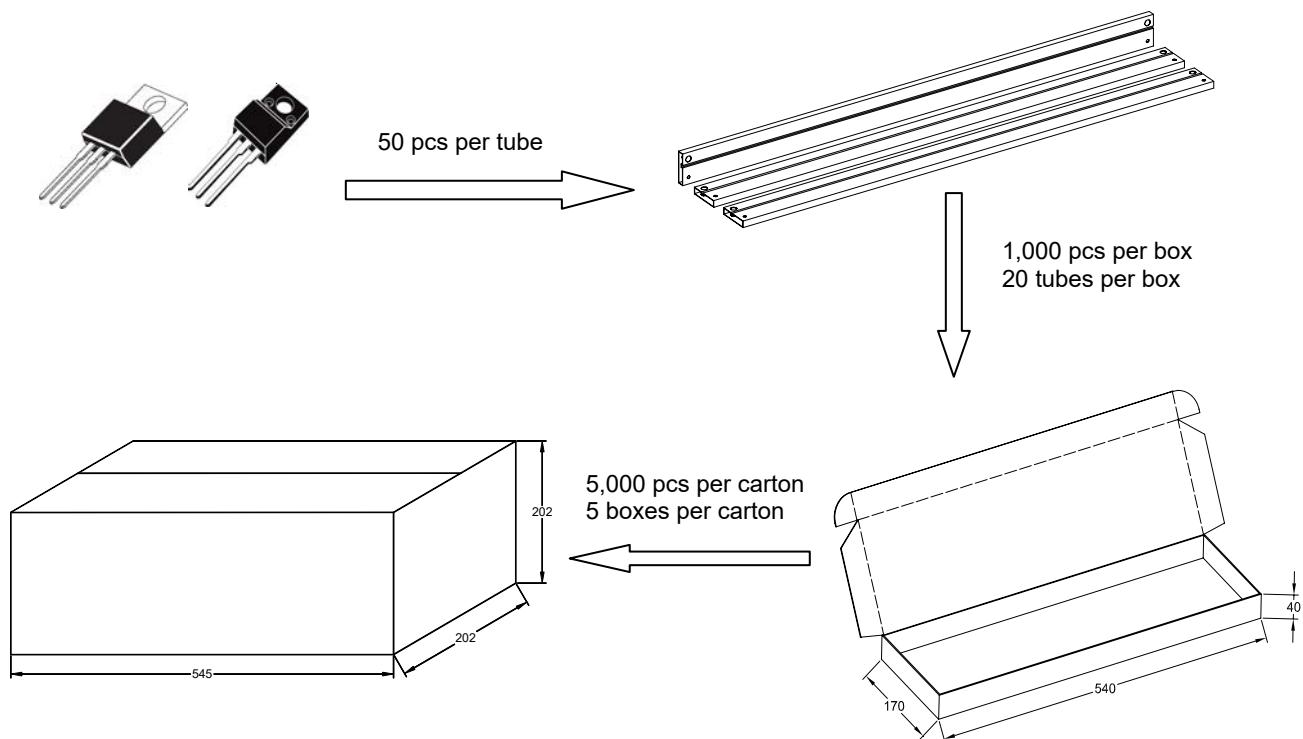
Times: one time

MSL:1 Level

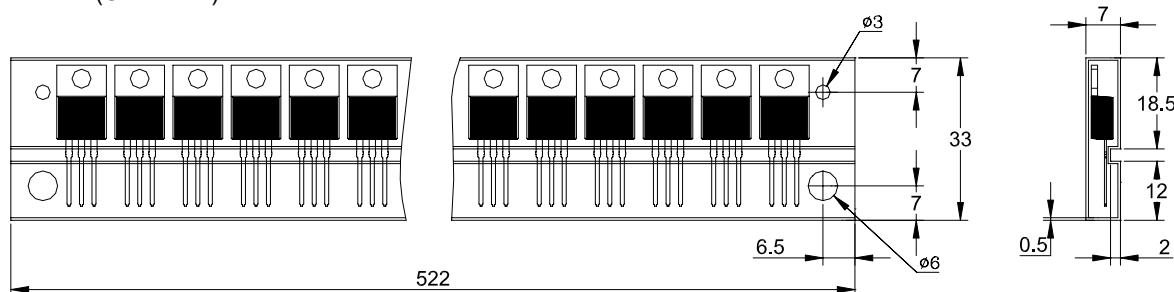


Packaging Specifications of Tube Pack for TO-220/TO-220F

1. The method of packaging and dimension are shown as below figure. (Dimension in mm)



2. Tube data (Units: mm)



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